

1 Characteristics

Table 2. Absolute maximum rating ($T_j = 25\text{ °C}$, unless otherwise specified)

Symbol	Parameter		Value	Unit	
$I_{T(RMS)}$	On-state rms current (full sine wave)		$T_c = 108\text{ °C}$	16	A
			$T_c = 119\text{ °C}$	12	
I_{TSM}	Non repetitive surge peak on-state current (full cycle, T_j initial = 25 °C)	F = 50 Hz	$t_p = 20\text{ ms}$	120	A
		F = 60 Hz	$t_p = 16.7\text{ ms}$	126	
I^2t	I^2t Value for fusing		$t_p = 10\text{ ms}$	95	A^2s
V_{DRM}/V_{RRM}	Repetitive peak off-state voltage, gate open		$T_j = 150\text{ °C}$	600	V
			$T_j = 125\text{ °C}$	800	
V_{DSM}, V_{RSM}	Non repetitive surge peak off-state voltage	$t_p = 10\text{ ms}$	$T_j = 25\text{ °C}$	900	V
di/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$		F = 100 Hz	100	A/ μs
I_{GM}	Peak gate current	$t_p = 20\text{ }\mu s$	$T_j = 150\text{ °C}$	4	A
$P_{G(AV)}$	Average gate power dissipation		$T_j = 150\text{ °C}$	1	W
T_{stg} T_j	Storage junction temperature range			-40 to +150	$^{\circ}C$
	Operating junction temperature range			-40 to +150	
T_L	Lead temperature for soldering during 10 s (at 4 mm from case for TO220AB-ins.)			260	$^{\circ}C$
V_{ins} (rms)	Insulation rms voltage, 1 minute, TO220AB ceramic insulated			2500	V

Table 3. Electrical characteristics ($T_j = 25\text{ °C}$, unless otherwise specified)

Symbol	Test conditions	Quadrant		Value		Unit	
				T1620T	T1635T		
$I_{GT}^{(1)}$	$V_D = 12\text{ V}$, $R_L = 30\ \Omega$	I - II - III	MIN.	1	1.75	mA	
			MAX.	20	35	mA	
V_{GT}	$V_D = 12\text{ V}$, $R_L = 30\ \Omega$	All	MAX.	1.3		V	
V_{GD}	$V_D = 800\text{ V}$, $R_L = 3.3\text{ k}\Omega$, $T_j = 125\text{ °C}$	All	MIN.	0.2		V	
$I_H^{(1)}$	$I_T = 500\text{ mA}$		MAX.	25	45	mA	
I_L	$I_G = 1.2 I_{GT}$	I - III	MAX.	35	55	mA	
		II		40	65		
$dV/dt^{(1)}$	$V_D = 67\% \times 800\text{ V}$ gate open		MIN.	$T_j = 125\text{ °C}$	1000	2000	V/ μs
	$V_D = 67\% \times 600\text{ V}$ gate open			$T_j = 150\text{ °C}$	500	1000	
$(dI/dt)_c^{(1)}$	$(dV/dt)_c = \text{snubberless} (> 20\text{ V}/\mu\text{s})$		MIN.	$T_j = 125\text{ °C}$	6	16	A/ms
				$T_j = 150\text{ °C}$	4.5	12	
t_{GT}	gate controlled turn on time $I_{TM} = 13\text{ A}$, $V_D = 400\text{ V}$, $I_G = 100\text{ mA}$, $dI_G/dt = 100\text{ mA}/\mu\text{s}$, $R_L = 30\ \Omega$	I - II - III	TYP.	2		μs	

1. For both polarities of A2 referenced to A1

Table 4. Static characteristics

Symbol	Test conditions			Value	Unit
$V_{TM}^{(1)}$	$I_{TM} = 22.6\text{ A}$, $t_p = 380\ \mu\text{s}$	$T_j = 25\text{ °C}$	MAX.	1.55	V
$V_{to}^{(1)}$	Threshold voltage	$T_j = 150\text{ °C}$	MAX.	0.85	V
$R_d^{(1)}$	Dynamic resistance	$T_j = 150\text{ °C}$	MAX.	30	$\text{m}\Omega$
I_{DRM} I_{RRM}	$V_{DRM} = V_{RRM} = 800\text{ V}$	$T_j = 25\text{ °C}$	MAX.	5	μA
		$T_j = 125\text{ °C}$		1	mA
	$V_{DRM} = V_{RRM} = 600\text{ V}$	$T_j = 150\text{ °C}$		3.6	

1. for both polarities of A2 referenced to A1

Table 5. Thermal resistance

Symbol	Parameter	Value	Unit
$R_{th(j-c)}$	Junction to case (AC)	2.1	$^{\circ}\text{C}/\text{W}$
$R_{th(j-a)}$	Junction to ambient	60	$^{\circ}\text{C}/\text{W}$

Figure 1. Maximum power dissipation versus on-state rms current (full cycle)

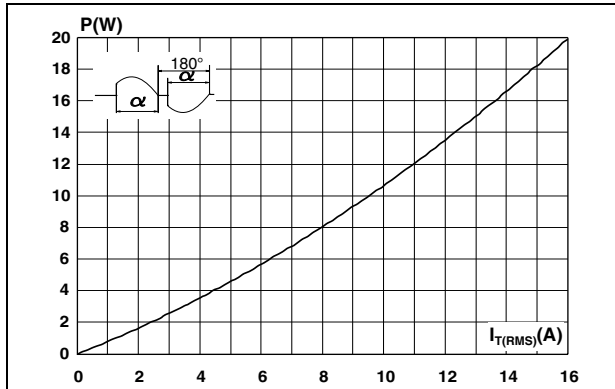


Figure 2. On-state rms current versus case temperature (full cycle)

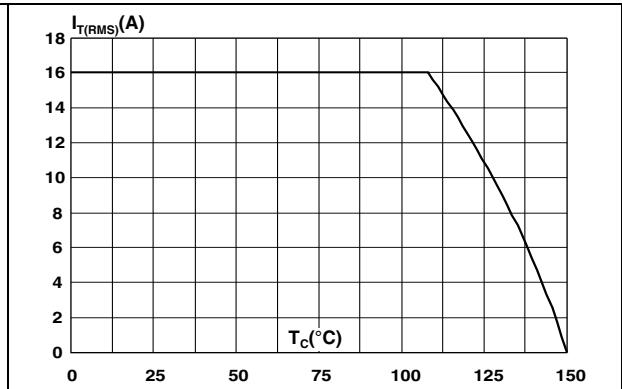


Figure 3. On-state rms current versus ambient temperature (free air convection)

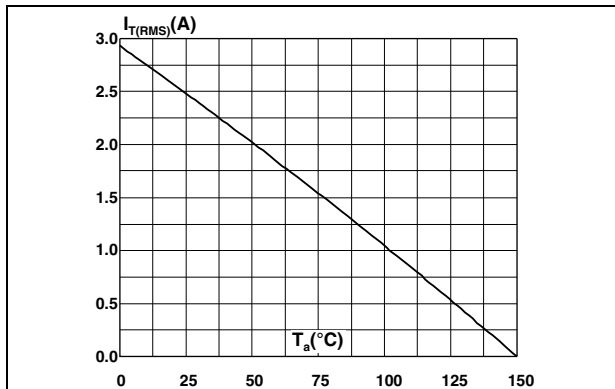


Figure 4. Relative variation of thermal impedance versus pulse duration

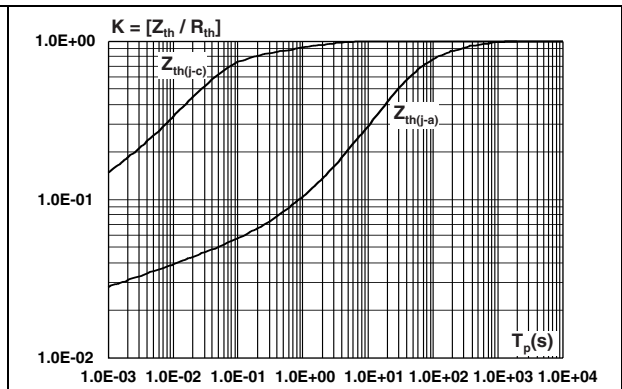


Figure 5. On-state characteristics (maximum values)

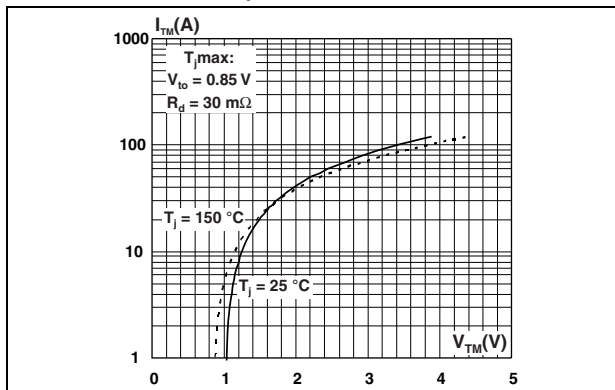


Figure 6. Surge peak on-state current versus number of cycles

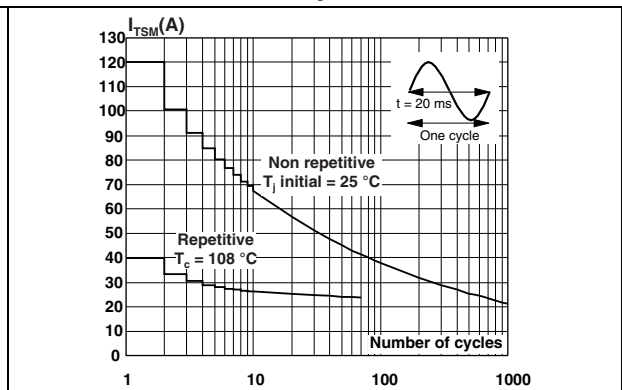


Figure 7. Non repetitive surge peak on-state current and corresponding values of I^2t

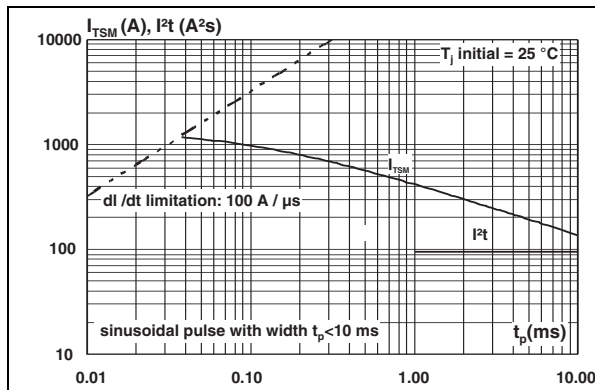


Figure 8. Relative variation of gate trigger current versus junction temperature

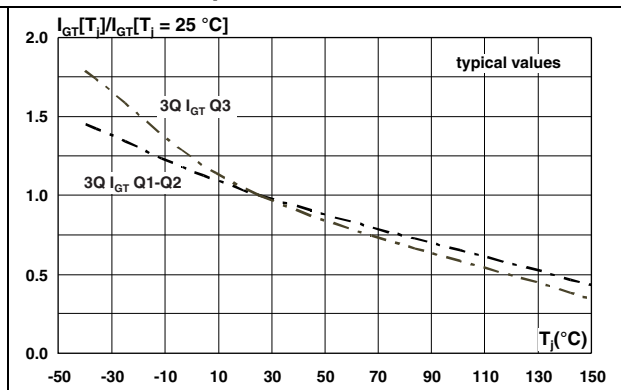


Figure 9. Relative variation of gate trigger voltage versus junction temperature

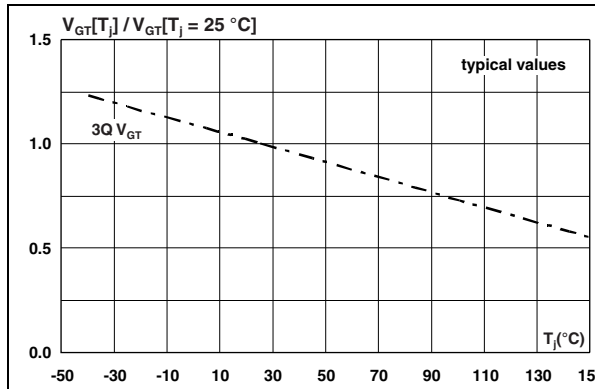


Figure 10. Relative variation of holding current and latching current versus junction temperature

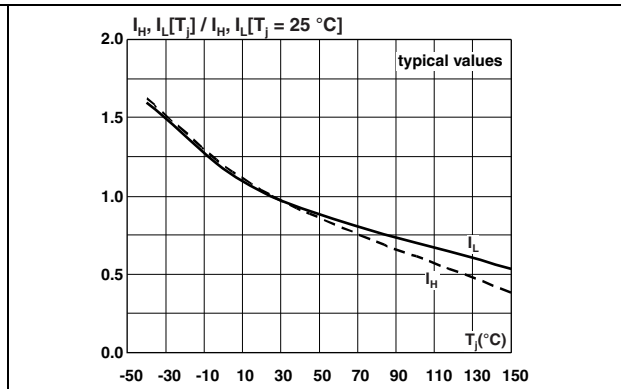


Figure 11. Relative variation of critical rate of decrease of main current (di/dt)c versus reapplied (dV/dt)c

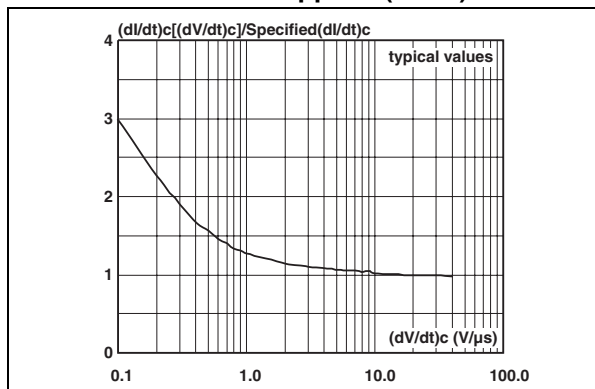


Figure 12. Relative variation of critical rate of decrease of main current (di/dt)c versus junction temperature

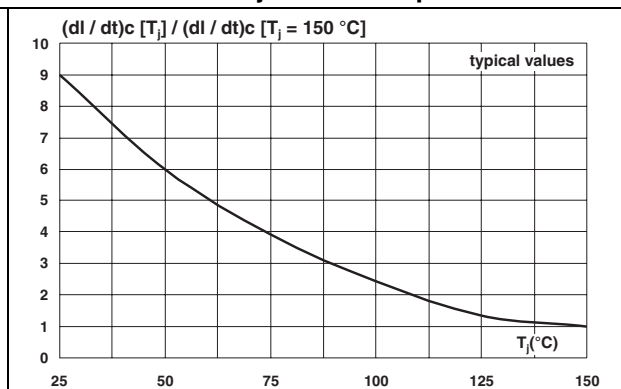
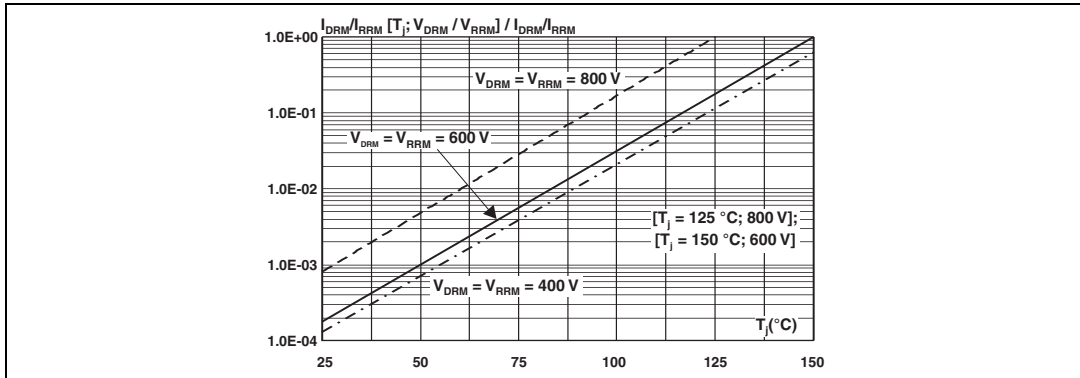


Figure 13. Relative variation of leakage current versus junction temperature for different values of blocking voltage



2 Package information

- Epoxy meets UL94, V0
- Recommended torque value: 0.4 to 0.6 N-m

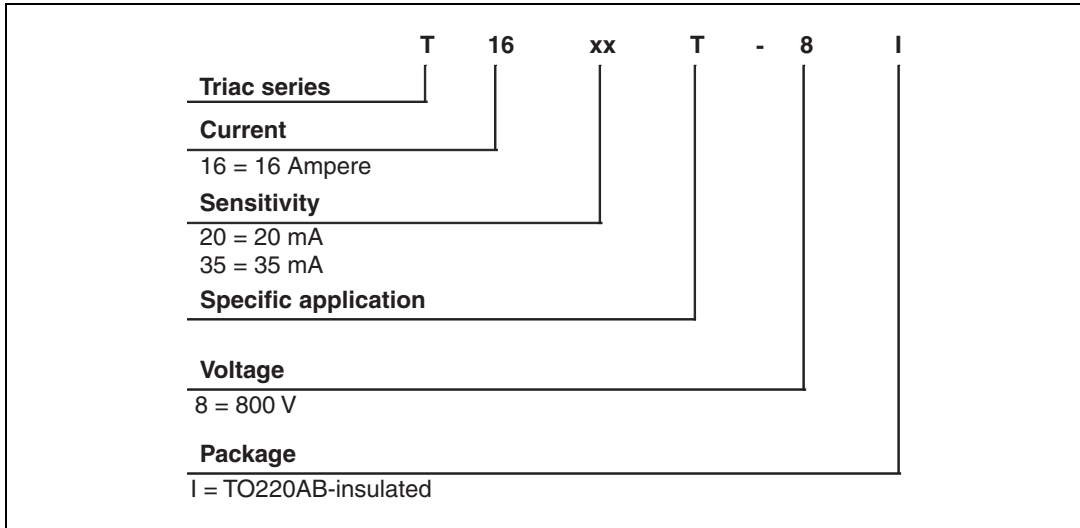
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Table 6. TO-220AB insulated dimensions

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	15.20		15.90	0.598		0.625
a1		3.75			0.147	
a2	13.00		14.00	0.511		0.551
B	10.00		10.40	0.393		0.409
b1	0.61		0.88	0.024		0.034
b2	1.23		1.32	0.048		0.051
C	4.40		4.60	0.173		0.181
c1	0.49		0.70	0.019		0.027
c2	2.40		2.72	0.094		0.107
e	2.40		2.70	0.094		0.106
F	6.20		6.60	0.244		0.259
ØI	3.75		3.85	0.147		0.151
I4	15.80	16.40	16.80	0.622	0.646	0.661
L	2.65		2.95	0.104		0.116
I2	1.14		1.70	0.044		0.066
I3	1.14		1.70	0.044		0.066
M		2.60			0.102	

3 Ordering information scheme

Figure 14. Ordering information scheme



4 Ordering information

Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
T1620T-8I	T1620T-8I	TO-220AB insulated	2.3	50	Tube
T1635T-8I	T1635T-8I	TO-220AB insulated	2.3	50	Tube

5 Revision history

Table 8. Document revision history

Date	Revision	Changes
20-Jan-2012	1	First issue.
25-Apr-2012	2	Updated UL certification.

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